International
IOR Rectifier
AN INFINEON TECHNOLOGIES COMPANY

IRS2005(S,M)PBF

High and Low Side Driver

Features

- Gate drive supplies up to 20V per channel
- Undervoltage lockout for V_{CC}, V_{BS}
- 3.3 V, 5V , 15V input logic compatible
- Tolerant to negative transient voltage
- Designed for use with bootstrap power supplies
- Matched propagation delays
- Output in phase with the Inputs
- -40°C to 125°C operating range
- RoHS compliant

Product Summary

V_{OFFSET}	≤ 200V
V_{OUT}	10 V – 20V
I_{o+} & I_{o-} (typ.)	290mA & 600mA
t_{ON} & t_{OFF} (typ.)	160ns & 150ns
Delay matching (max.)	50ns

Description

The IRS2005 is a high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 200 V. Propagation delays are matched to simplify the HVIC's use in high frequency applications.

Package Options

8-Lead SOIC

16-Lead MLPQ 4x4
(without 2 leads)

Typical Applications

- Appliance motor drives
- Servo drives
- Micro inverter drives
- General purpose three phase inverters

Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
IRS2005SPBF	8-Lead SOIC	Tube/Bulk	95	IRS2005SPBF
		Tape and Reel	2500	IRS2005STRPBF
IRS2005MPBF	14-Lead MLPQ 4x4	Tape and Reel	3000	IRS2005MTRPBF

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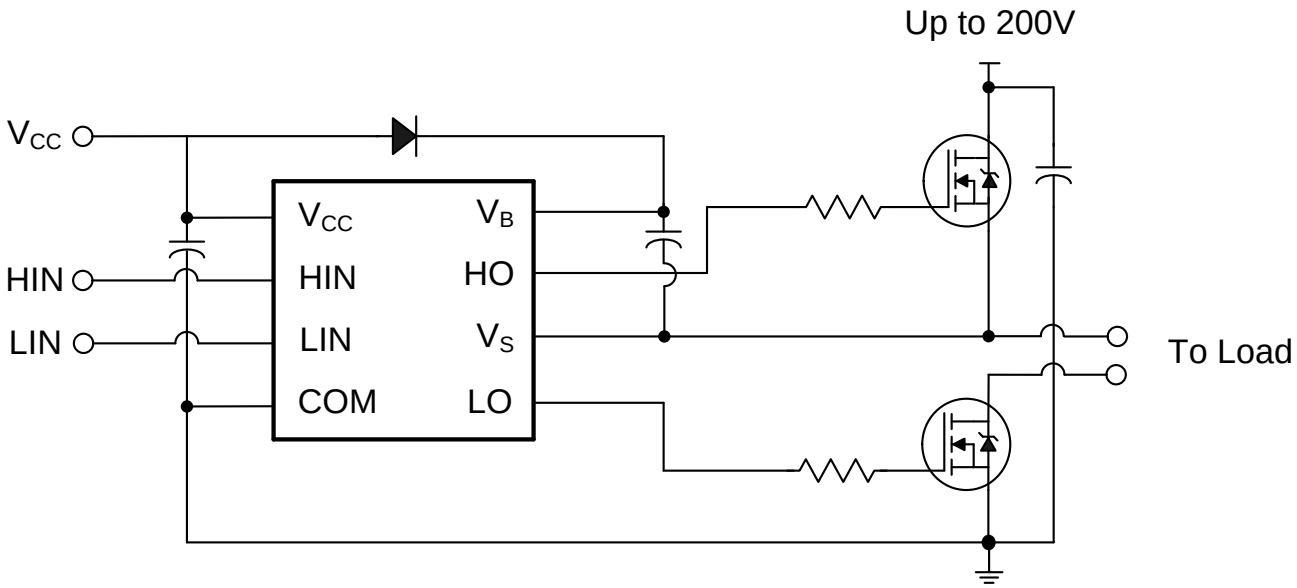
Typical Connection Diagram



(Refer to Lead Assignments for correct pin configuration). This diagram shows electrical connections only. Please refer tour Application Notes & DesignTips for proper circuit board layout.

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Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition		Min.	Max.	Units
V_{CC}	Low side supply voltage		-0.3	25†	V
V_{IN}	Logic input voltage		COM - 0.3	V_{CC} + 0.3	
V_B	High-side floating well supply voltage		-0.3	225	
V_S	High-side floating well supply return voltage		V_B- 25	V_B + 0.3	
V_{HO}	Floating gate drive output voltage		V_S - 0.3	V_B + 0.3	
V_{LO}	Low-side output voltage		COM - 0.3	V_{CC} + 0.3	
COM	Power ground		V_{CC} - 25	V_{CC} + 0.3	
dV_S/dt	Allowable V_S offset supply transient relative to COM		—	50	V/ns
P_D	Package power dissipation @ T_A ≤+25ºC	8-Lead SOIC	—	0.625	W
		14-Lead MLPQ 4x4	—	2.08	
Rth_{JA}	Thermal resistance, junction to ambient	8-Lead SOIC	—	200	ºC/W
		14-Lead MLPQ 4x4	—	36	
T_J	Junction temperature		—	150	ºC
T_S	Storage temperature		-55	150	
T_L	Lead temperature (soldering, 10 seconds)		—	300	

† All supplies are tested at 25V.

Recommended Operating Conditions

For proper operation, the device should be used within the recommended conditions. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The offset rating is tested with supplies of (V_{CC} - COM) = (V_B - V_S) = 15V.

Symbol	Definition	Min	Max	Units
V_{CC}	Low-side supply voltage	10	20	V
V_{IN}	Logic input voltage	0	V_{CC}	
V_B	High-side floating well supply voltage	V_S + 10	V_S + 20	
V_S	High-side floating well supply offset voltage†	COM - 8†	200	
V_{HO}	Floating gate drive output voltage	V_s	V_B	
V_{LO}	Low-side output voltage	COM	V_{CC}	
T_A	Ambient temperature	-40	125	ºC

† Logic operation for VS of –8 V to 200 V. Logic state held for V_S of –8 V to –V_{BS}. Please refer to Design Tip DT97-3 for more details.

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Static Electrical Characteristics

(V_{CC} - COM) = (V_B - V_S) = 15V. T_A = 25°C unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to respective V_S and COM and are applicable to the respective output leads HO or LO. The V_{CCUV} parameters are referenced to COM. The V_{BSUV} parameters are referenced to V_S.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
V_{BSUV+}	V_{BS} supply undervoltage positive going threshold	8.0	8.9	9.8	V	
V_{BSUV-}	V_{BS} supply undervoltage negative going threshold	7.4	8.2	9		
V_{BSUVHY}	V_{BS} supply undervoltage hysteresis	—	0.7	—		
V_{CCUV+}	V_{CC} supply undervoltage positive going threshold	8.0	8.9	9.8		
V_{CCUV-}	V_{CC} supply undervoltage negative going threshold	7.4	8.2	9		
V_{CCUVHY}	V_{CC} supply undervoltage hysteresis	—	0.7	—		
I_{LK}	High-side floating well offset supply leakage	—	—	50	µA	V_B = V_S = 200V
I_{QBS}	Quiescent V_{BS} supply current	—	45	75		All inputs are in the off state
I_{QCC}	Quiescent V_{CC} supply current	—	300	520		
V_{OH}	High level output voltage drop, V_{BIAS}-V_O	—	0.05	0.2	V	I_O = 2 mA
V_{OL}	Low level output voltage drop, V_O	—	0.02	0.1		
I_{o+}	Output high short circuit pulsed current	200	290	—	mA	V_O = 0V, V_{IN} = 0V PW ≤ 10µs
I_{o-}	Output low short circuit pulsed current	420	600	—		V_O = 15V, V_{IN} = 5V PW ≤ 10µs
V_{IH}	Logic “1” input voltage	2.5	—	—	V	
V_{IL}	Logic “0” input voltage	—	—	0.8		
I_{IN+}	Input bias current (HO = High)	—	3	10	µA	V_{IN} = 5V
I_{IN-}	Input bias current (HO = Low)	—	—	5		V_{IN} = 0V

Dynamic Electrical Characteristics

V_{CC} = V_B = 15V, V_S = COM, T_A = 25°C, and C_L = 1000pF unless otherwise specified.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
t_{ON}	Turn-on propagation delay	—	160	220	ns	V_S = 0V or 200V
t_{OFF}	Turn-off propagation delay	—	150	220		
t_R	Turn-on rise time	—	70	170		V_S = 0V
t_F	Turn-off fall time	—	30	90		
t_{FIL}	Minimum pulse input filter time	—	300	—		
MT	Delay matching time (t_{ON}, t_{OFF})	—	—	50		

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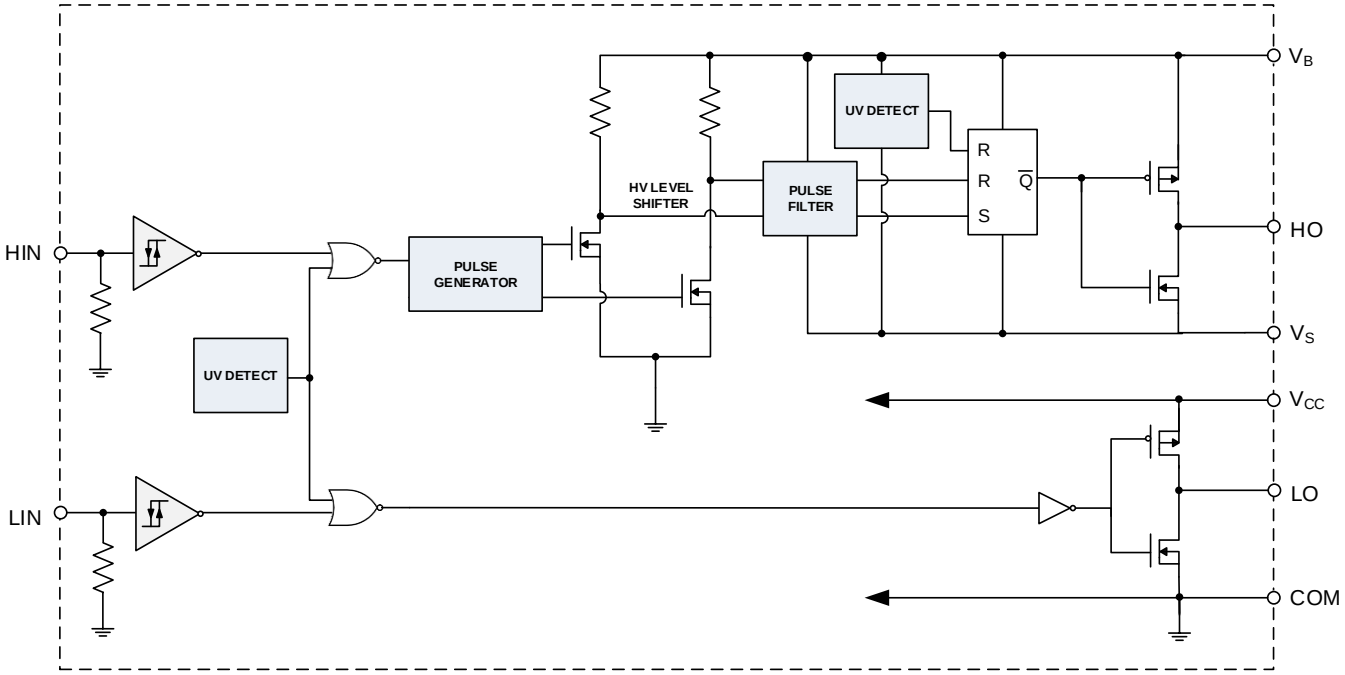
Functional Block Diagram



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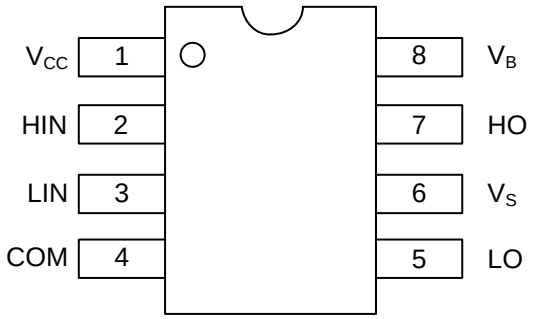
Lead Definitions

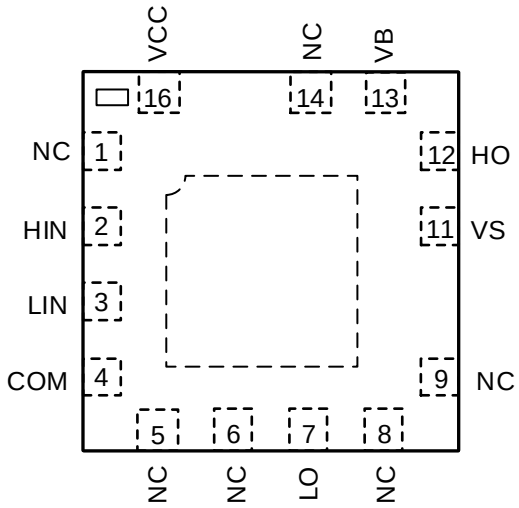
Symbol	Description
VCC	Low-side and logic supply voltage
VB	High-side gate drive floating supply
VS	High voltage floating supply return
HIN	Logic inputs for high-side gate driver output (HO), in phase
LIN	Logic inputs for low-side gate driver output (LO), in phase
HO	High-side driver output
LO	Low-side driver output
COM	Low-side gate drive return

Lead Assignments



8-Lead SOIC

IRS2005S



16-Lead MLPQ 4x4

IRS2005M

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Application Information and Additional Details

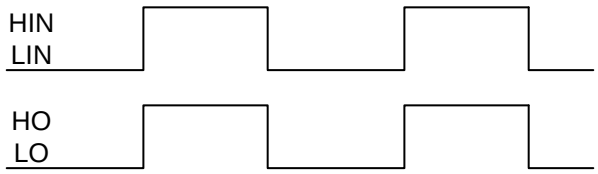

Figure 1. Input/Output Timing Diagram

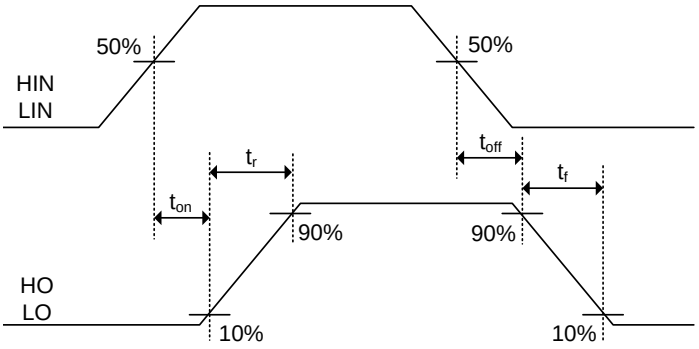

Figure 2. Switching Time Waveform Definitions

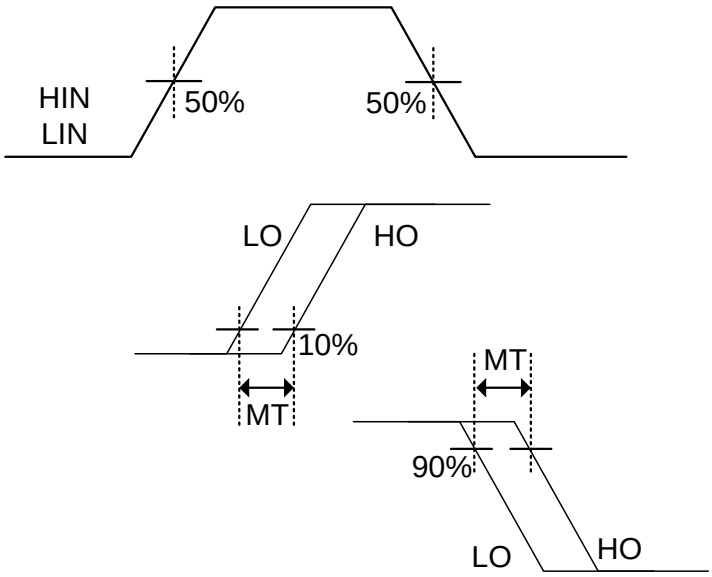

Figure 3. Delay Matching Waveform Definitions

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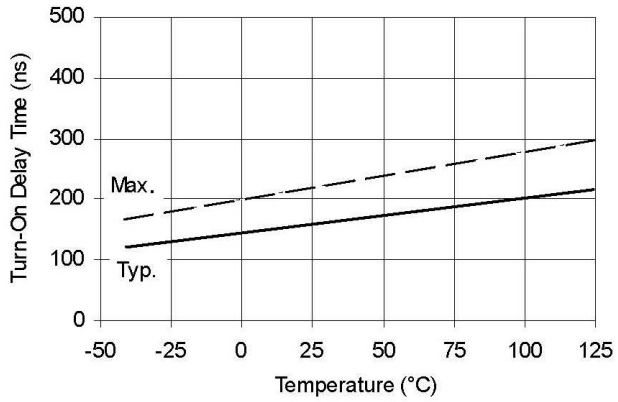

Figure 4A. Turn-On Delay Time vs. Temperature

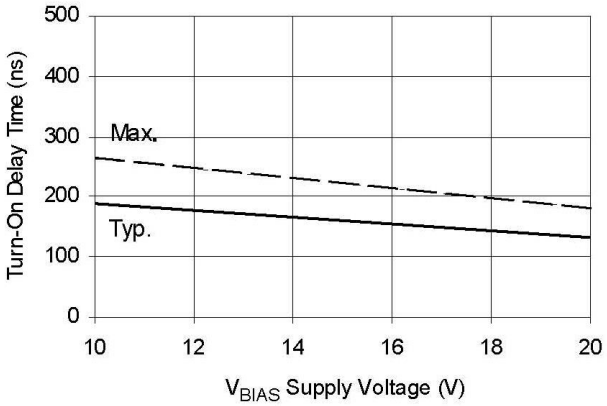

Figure 4B. Turn-On Delay Time vs. Supply Voltage

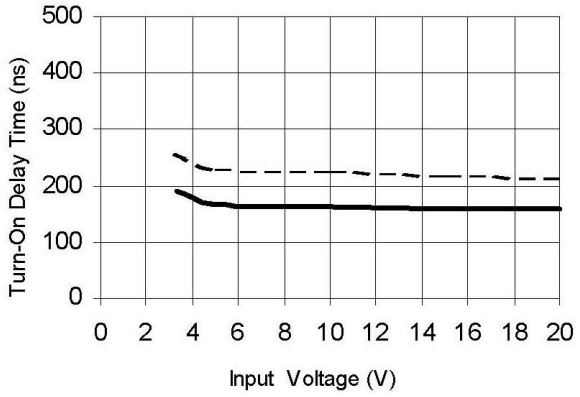

Figure 4C. Turn-On Delay Time vs. Input Voltage

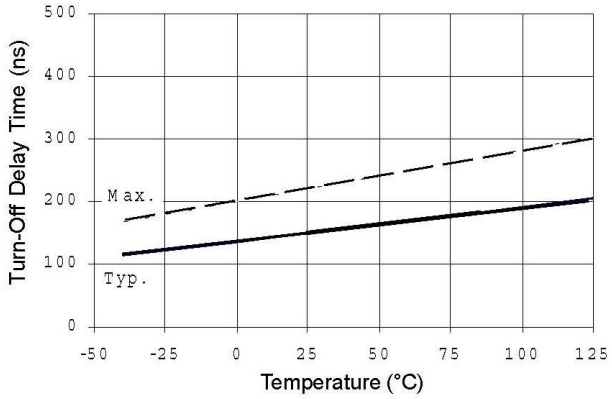

Figure 5A. Turn-Off Delay Time vs. Temperature

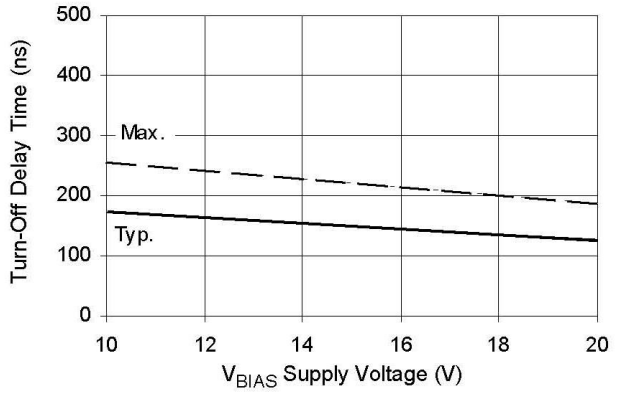

Figure 5B. Turn-Off Delay Time vs. Supply Voltage

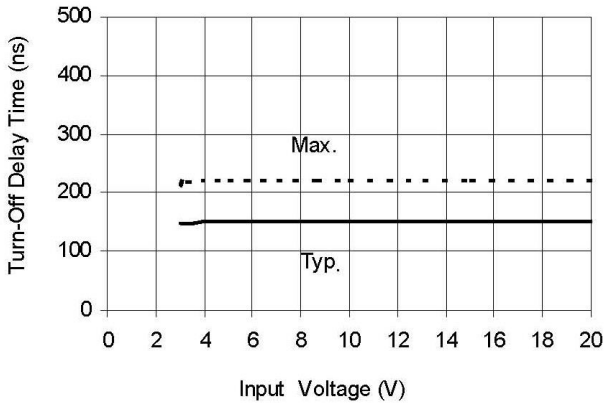

Figure 5C. Turn-Off Time vs. Input Voltage

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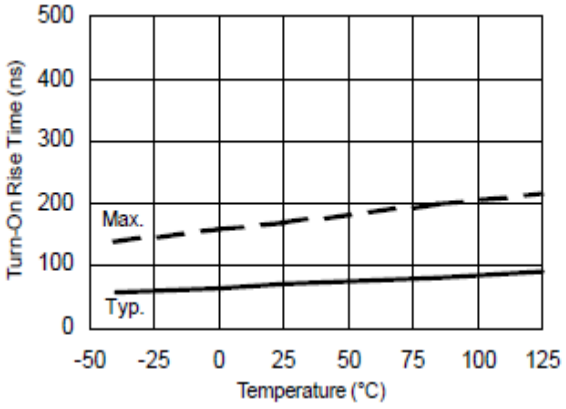

Figure 6A. Turn-On Rise Time vs. Temperature

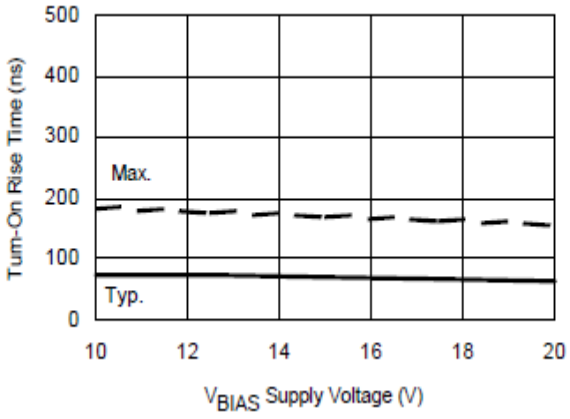

Figure 6B. Turn-On Rise Time vs. Voltage

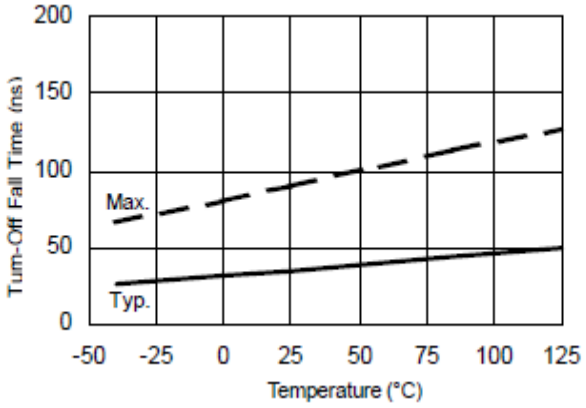

Figure 7A. Turn-Off Fall Time vs. Temperature

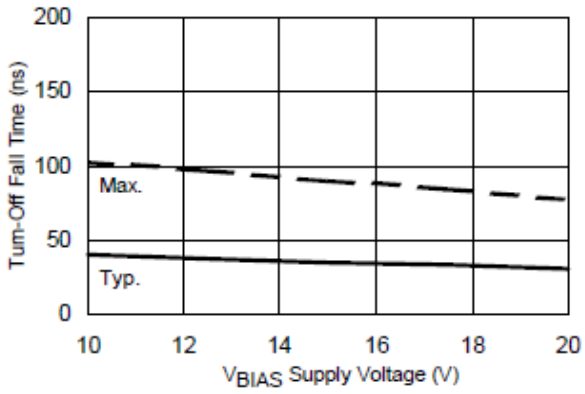

Figure 7B. Turn-Off Fall Time vs. Voltage

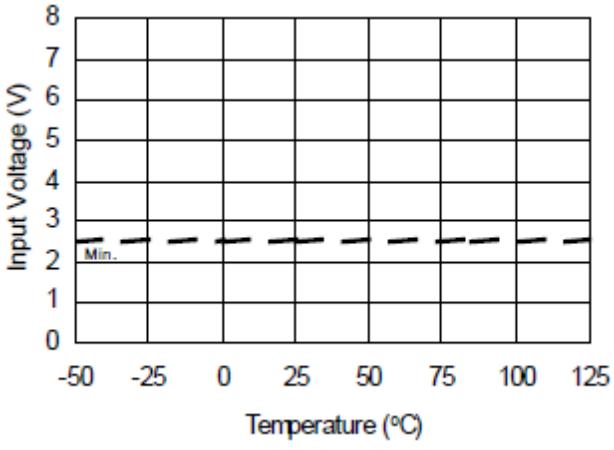

Figure 8A. Logic "1" Input Voltage vs. Temperature

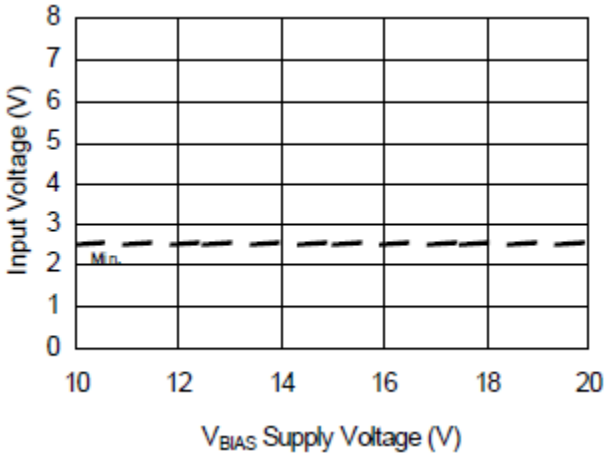

Figure 8B. Logic "1" Input Voltage vs. Voltage

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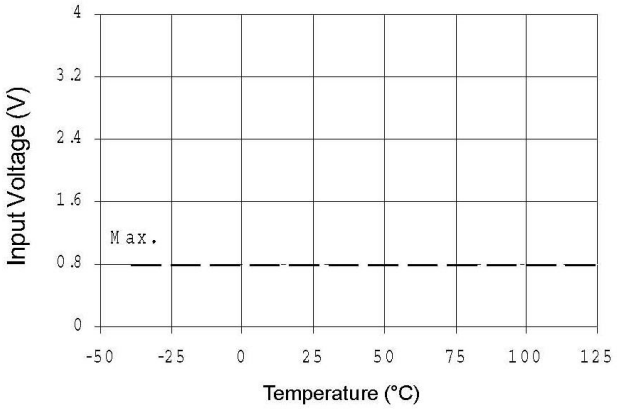

Figure 9A. Logic "0" Input Voltage vs. Temperature

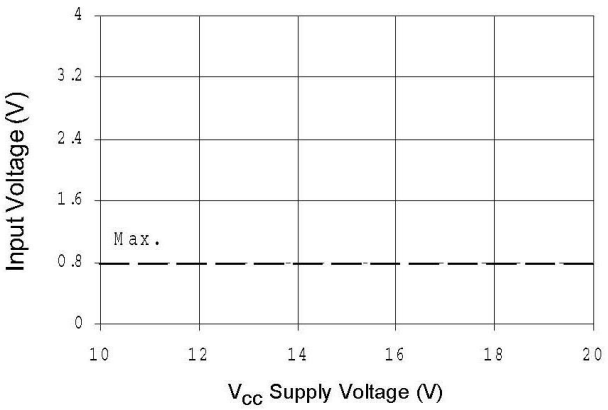

Figure 9B. Logic "0" Input Voltage vs. Supply Voltage

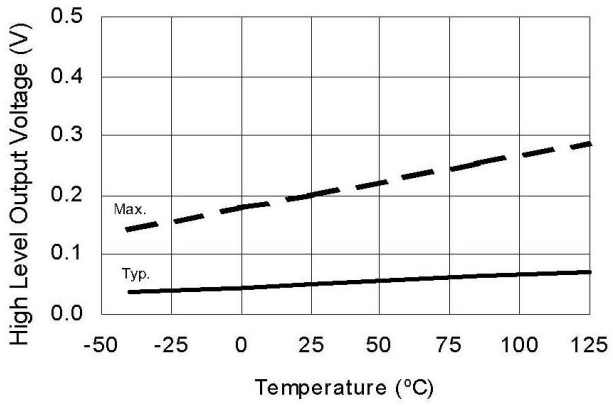

Figure 10A. High Level Output Voltage vs. Temperature

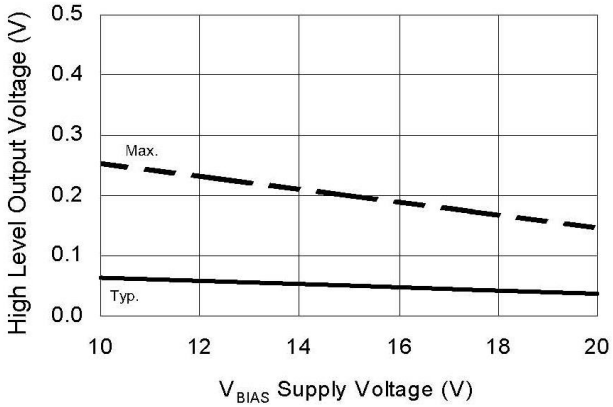

Figure 10B. High Level Output vs. Supply Voltage

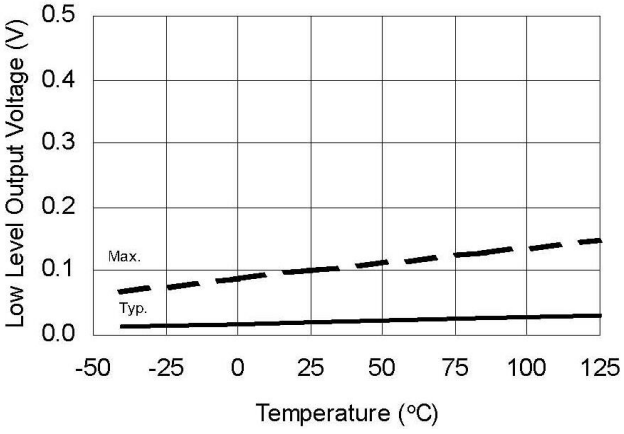

Figure 11A. Low Level Output Voltage vs. Temperature

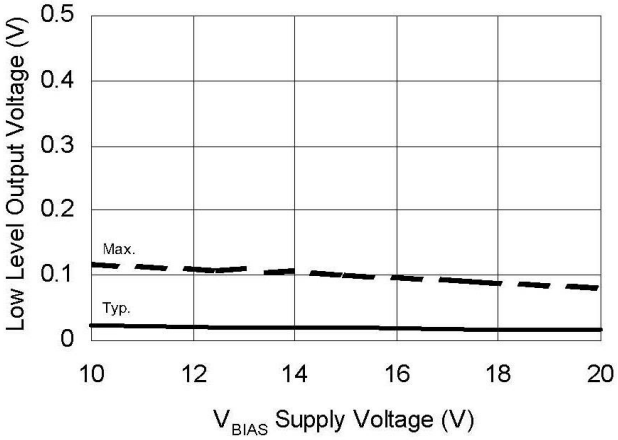

Figure 11B. Low Level Output vs. Supply Voltage

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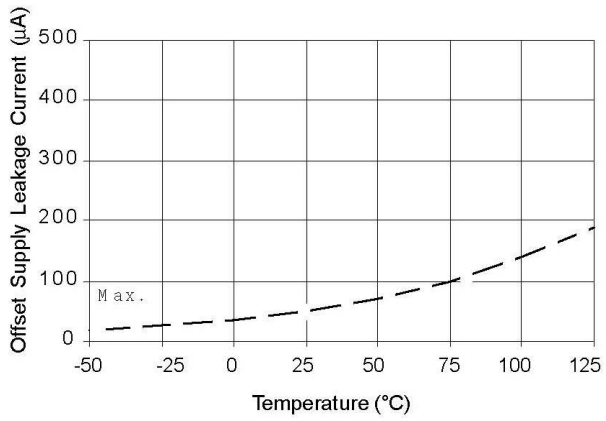

Figure 12A. Offset Supply Current vs. Temperature

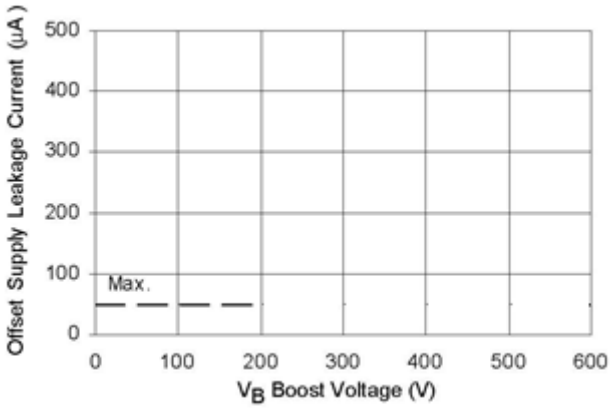

Figure 12B. Offset Supply Current vs. Voltage

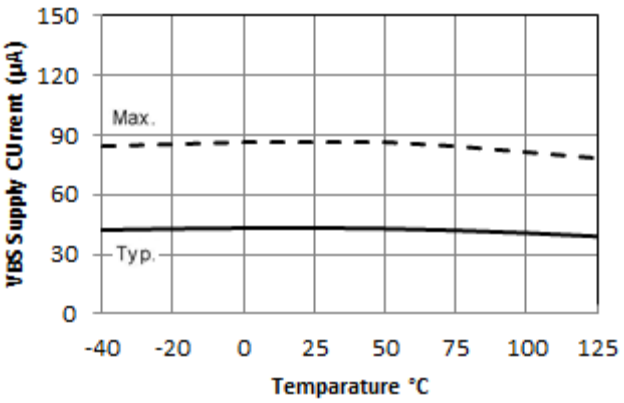

Figure 13A. V_{BS} Supply Current vs. Temperature

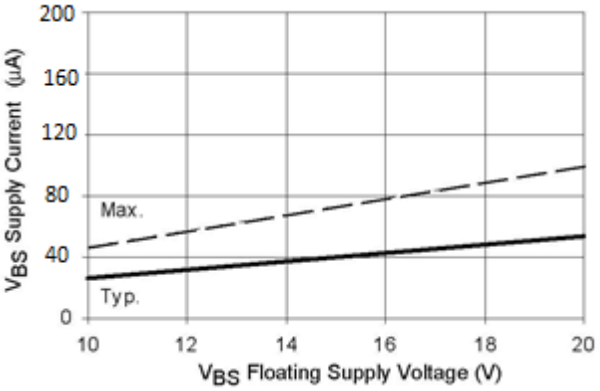

Figure 13B. V_{BS} Supply Current vs. Voltage

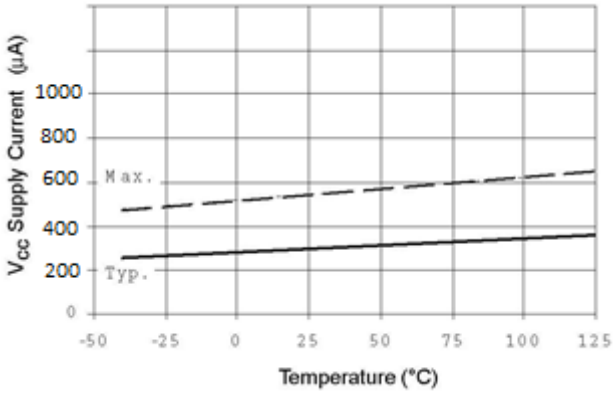

Figure 14A. V_{CC} Supply Current vs. Temperature

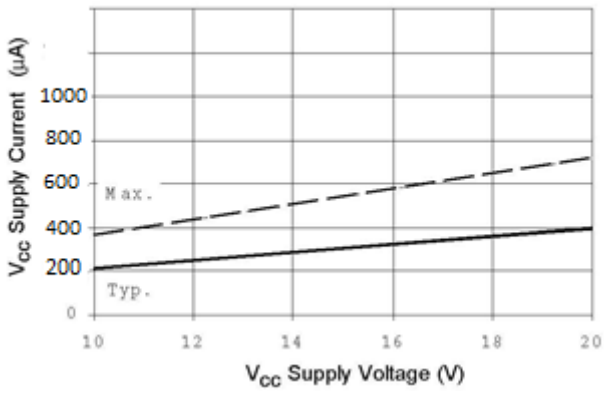

Figure 14B. V_{CC} Supply Current vs. Voltage

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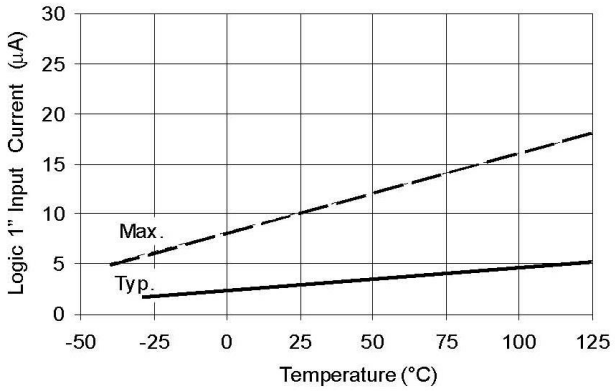

Figure 15A. Logic "1" Input Current vs. Temperature

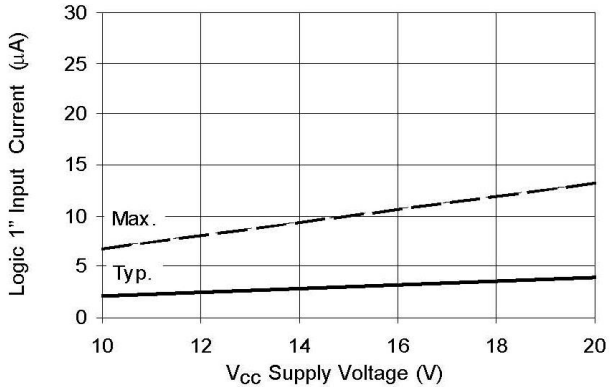

Figure 15B. Logic "1" Input Current vs. Voltage

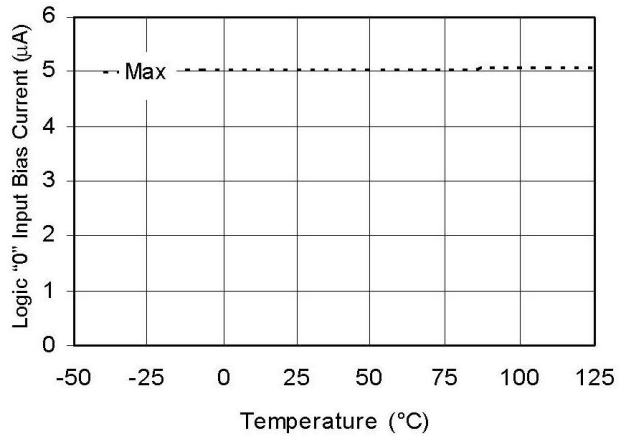

Figure 16A. Logic "0" Input Bias Current

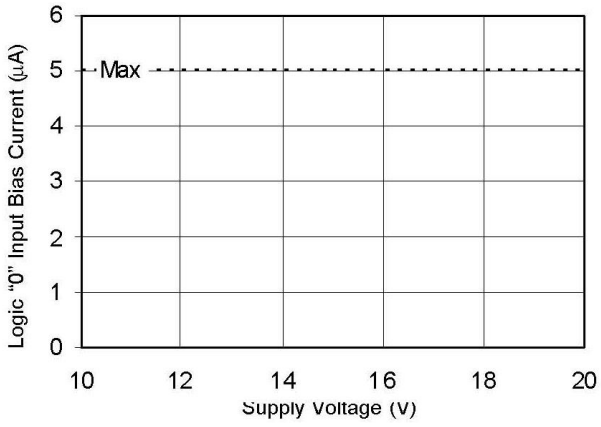

Figure 16B. Logic "0" Input Bias Current

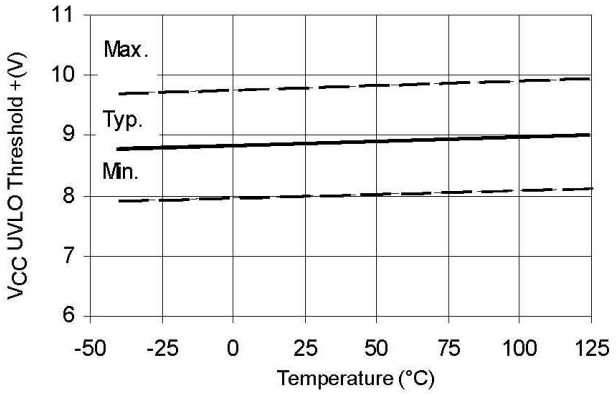

Figure 17A. V_{CC}\V_{BS} Undervoltage Threshold(+) vs. Temperature

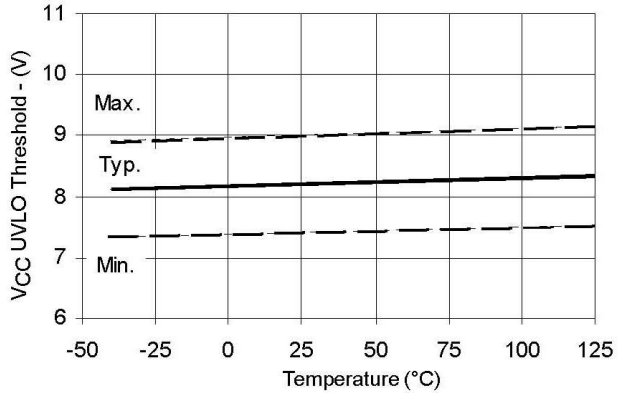

Figure 17B. V_{CC}\V_{BS} Undervoltage Threshold(-) vs. Temperature

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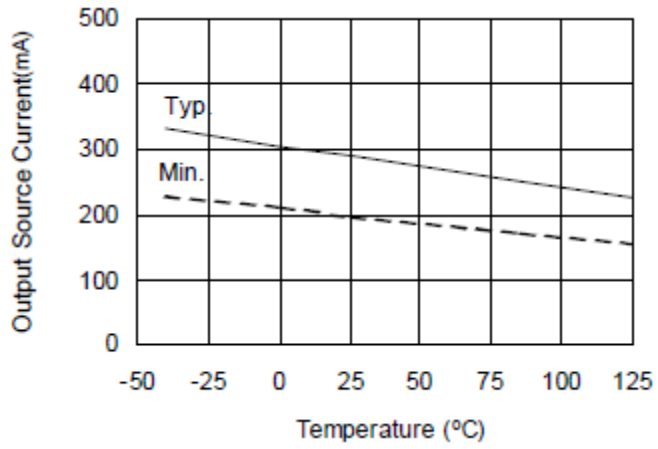

Figure 18A. Output Source Current vs. Temperature

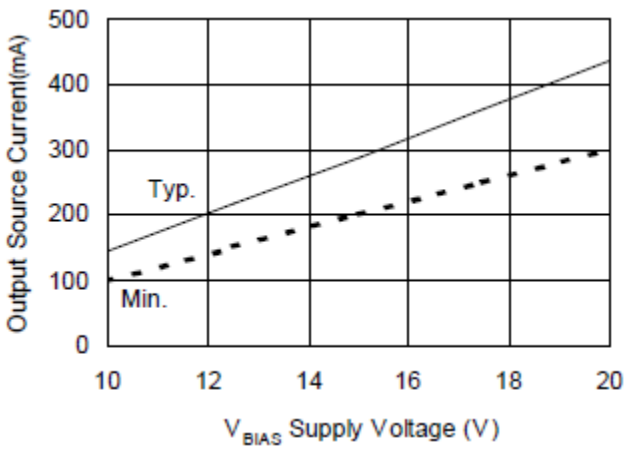

Figure 18B. Output Source Current vs. Supply Current

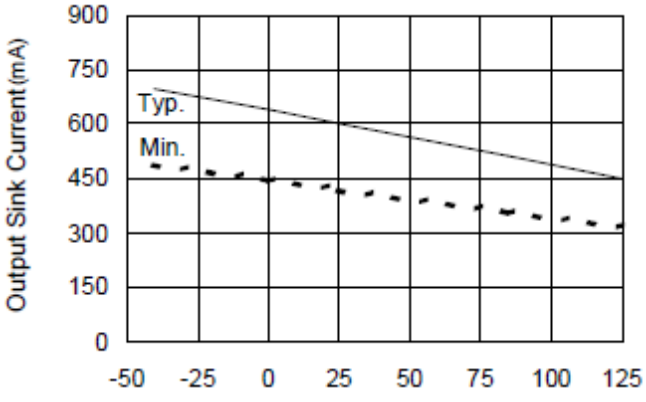

Figure 19A. Output Sink Current vs. Temperature

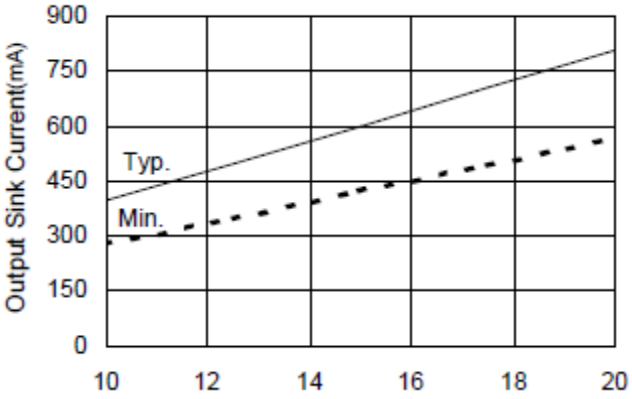

Figure 19B. Output Sink Current vs. Supply Voltage

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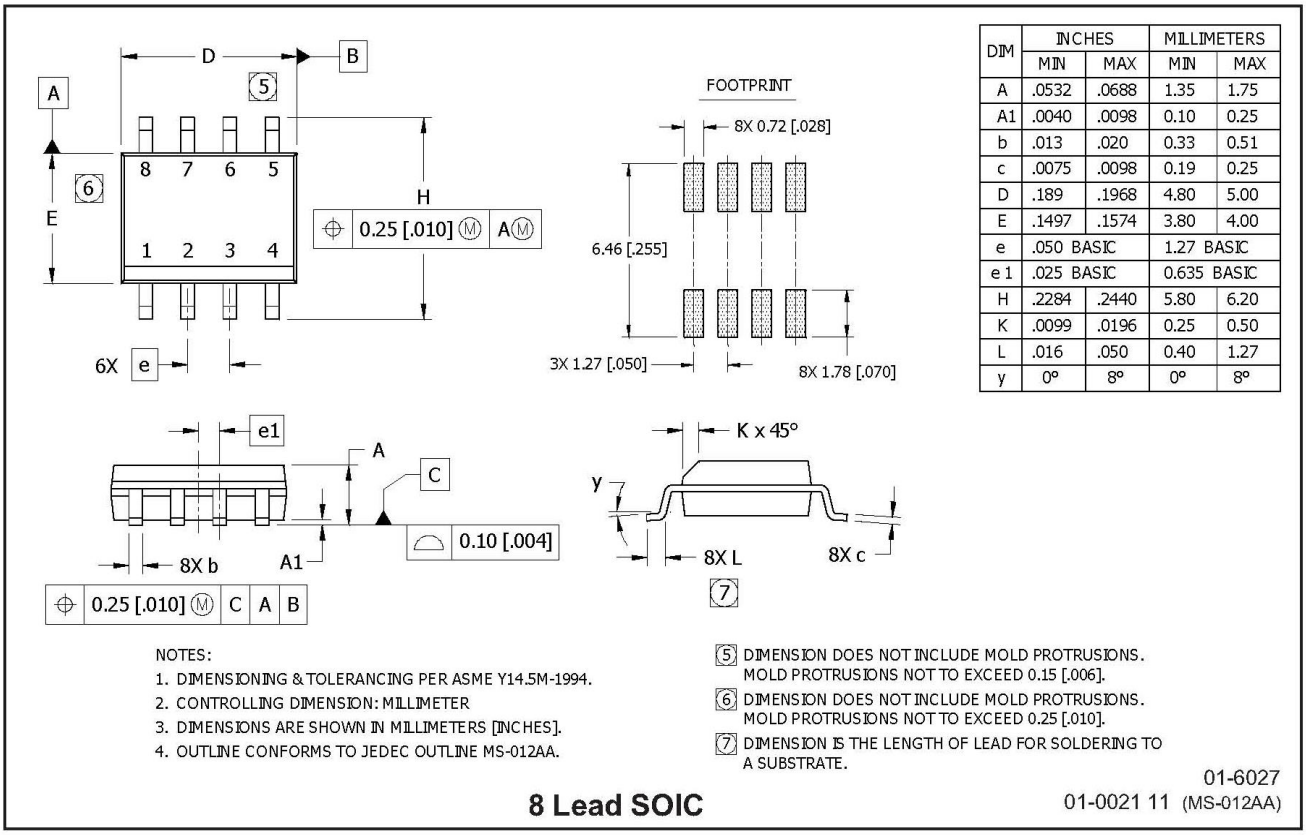
Package Details: 8-Lead SOIC



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e 1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

NOTES:
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.

5 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [.006].
6 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.010].
7 DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

01-6027
01-0021 11 (MS-012AA)

8 Lead SOIC

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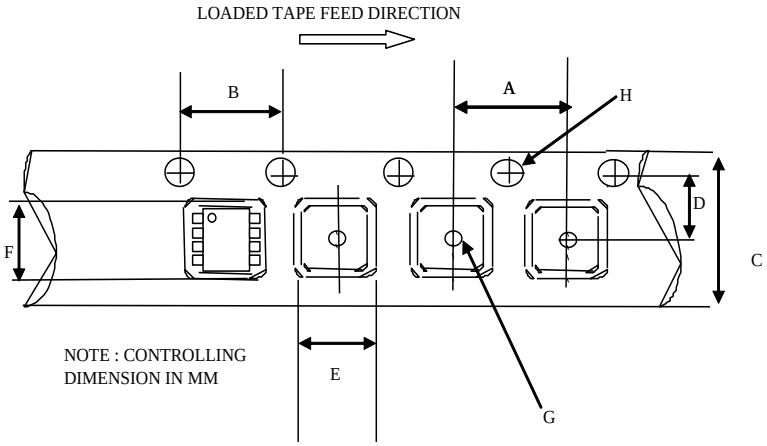
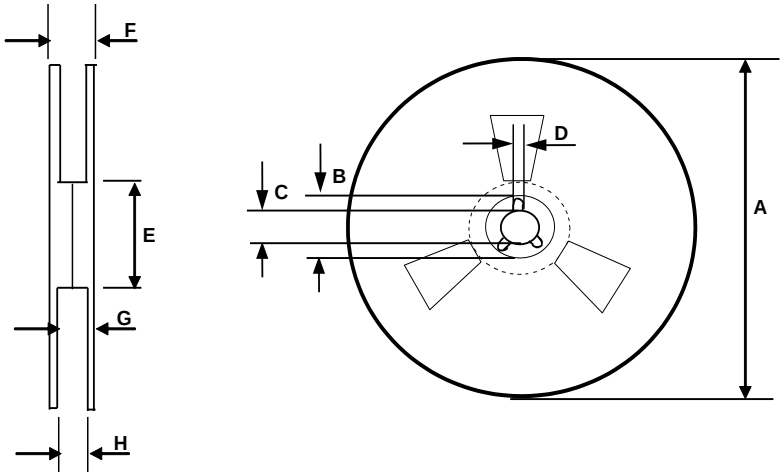
Tape and Reel Details: 8-Lead SOIC



CARRIER TAPE DIMENSION FOR 8SOICN

	Metric		Imperial	
Code	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

	Metric		Imperial	
Code	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

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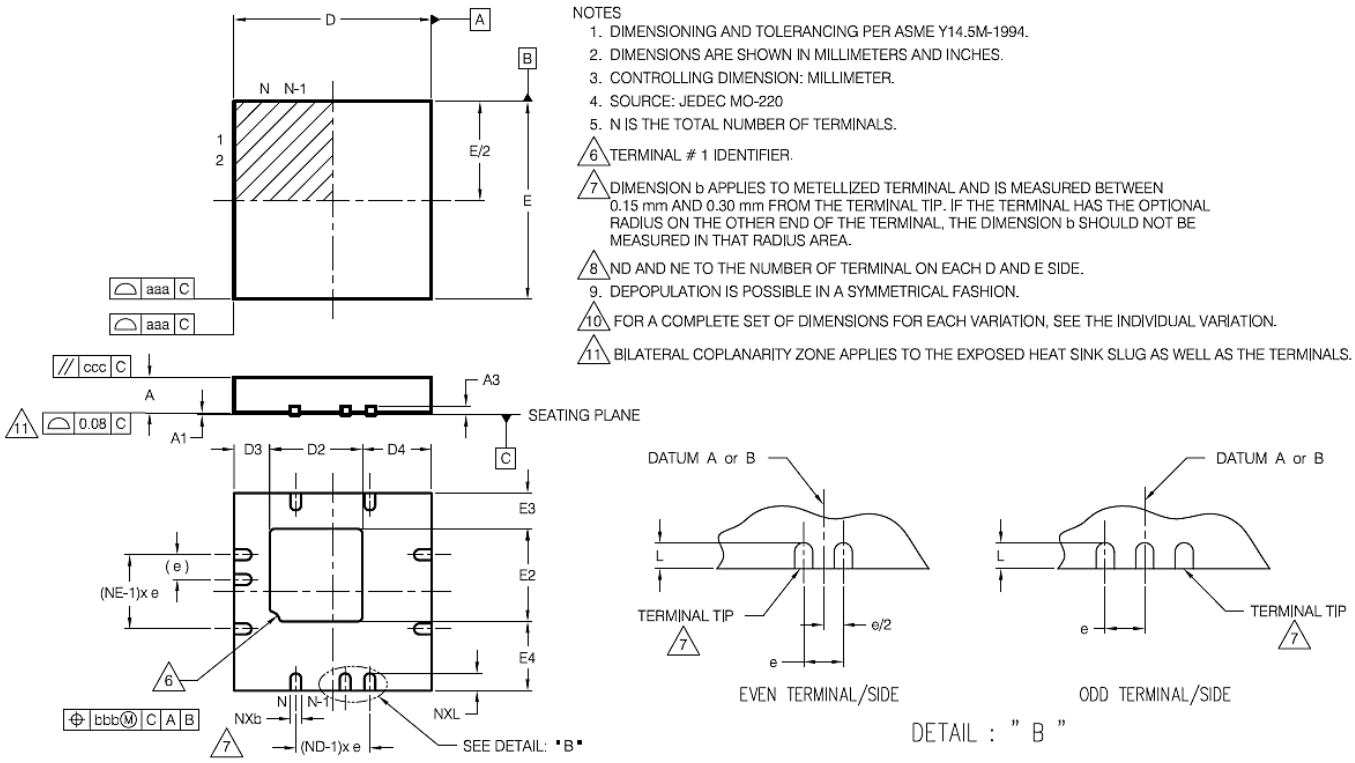
Package Details: 14-Lead MLPQ 4x4



NOTES

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. DIMENSIONS ARE SHOWN IN MILLIMETERS AND INCHES.
3. CONTROLLING DIMENSION: MILLIMETER.
4. SOURCE: JEDEC MO-220
5. N IS THE TOTAL NUMBER OF TERMINALS.

6 TERMINAL # 1 IDENTIFIER.

7 DIMENSION b APPLIES TO METELLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 mm AND 0.30 mm FROM THE TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION b SHOULD NOT BE MEASURED IN THAT RADIUS AREA.

8 ND AND NE TO THE NUMBER OF TERMINAL ON EACH D AND E SIDE.

9. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

10 FOR A COMPLETE SET OF DIMENSIONS FOR EACH VARIATION, SEE THE INDIVIDUAL VARIATION.

11 BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

SYMBOL	VGGD-10					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	.032	.035	.039
A1	0.00	0.02	0.05	.000	.0008	.0019
A3	0.20 REF			.008 REF		
b	0.18	0.25	0.30	.007	.010	.012
D2	1.78	1.88	1.98	.070	.074	.078
D3	0.73 REF			.029 REF		
D4	1.40 REF			.055 REF		
D	4.00 BSC			.157 BSC		
E	4.00 BSC			.157 BSC		
E4	1.40 REF			.055 REF		
E3	0.73 REF			.029 REF		
E2	1.78	1.88	1.98	.070	.074	.078
L	0.30	0.40	0.50	.012	.016	.020
e	0.50 PITCH			.020 PITCH		
N	16			16		
ND	4			4		
NE	4			4		
aaa	0.15			.0059		
bbb	0.10			.0039		
ccc	0.10			.0039		
ddd	0.05			.0019		

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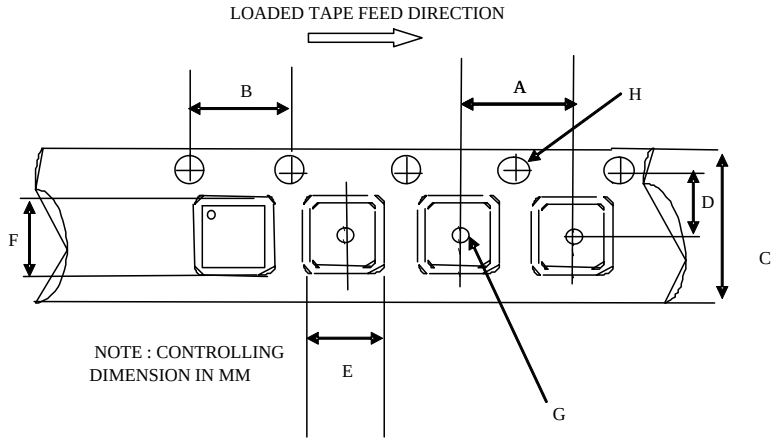
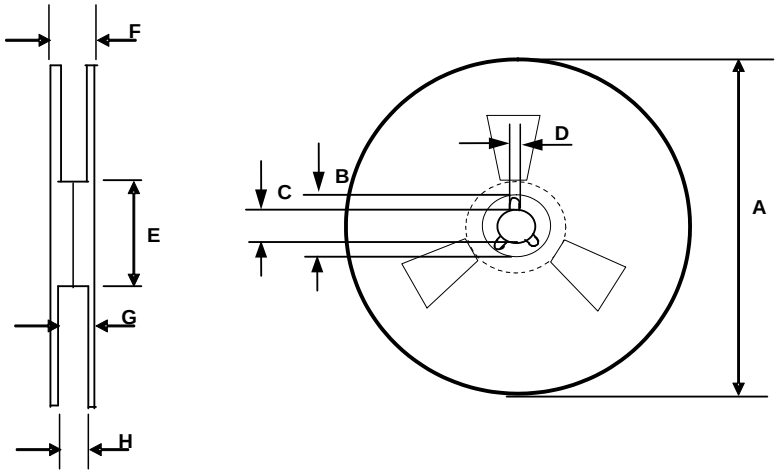
Tape and Reel Details: 14-Lead MLPQ 4x4



CARRIER TAPE DIMENSION FOR MLPQ4x4

	Metric		Imperial	
Code	Min	Max	Min	Max
A	7.90	8.10	0.311	0.358
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.461	0.484
D	5.45	5.55	0.215	0.219
E	4.25	4.45	0.168	0.176
F	4.25	4.45	0.168	0.176
G	1.50	n/a	0.069	n/a
H	1.50	1.60	0.069	0.063



REEL DIMENSIONS FOR MLPQ4x4

	Metric		Imperial	
Code	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

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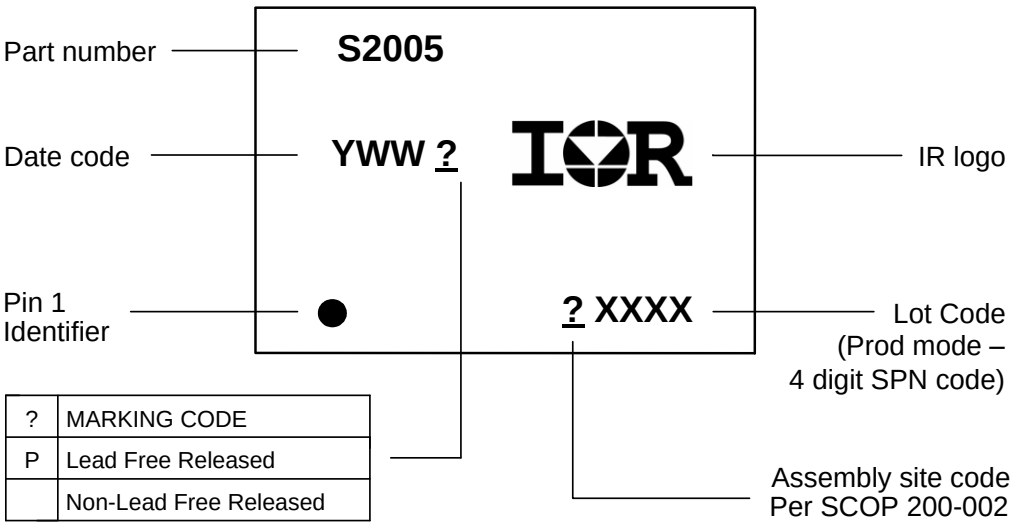
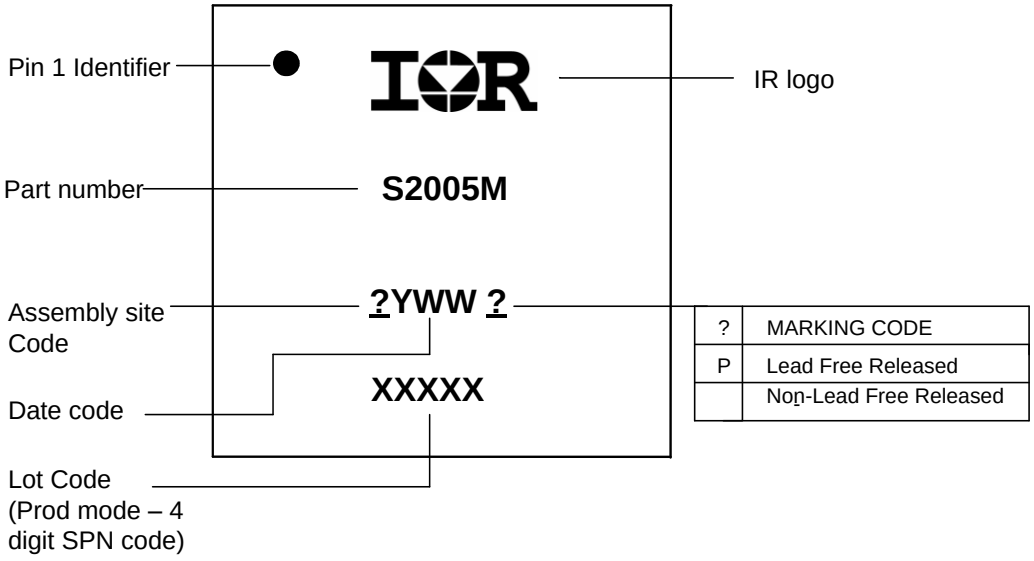
Part Marking Information



?	MARKING CODE
P	Lead Free Released
	Non-Lead Free Released

8-Lead SOIC8
IRS2005SPBF



?	MARKING CODE
P	Lead Free Released
	Non-Lead Free Released

14-Lead MLPQ 4x4
IRS2005MPBF

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Qualification Information†

Qualification Level		Industrial††	
		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.	
Moisture Sensitivity Level		8 Lead SOIC	MSL2†††, 260°C (per IPC/JEDEC J-STD-020)
		14-Lead MLPQ 4x4	
ESD	Human Body Model	Class 2 (per JEDEC standard JESD22-A114)	
	Machine Model	Class A (per EIA/JEDEC standard EIA/JESD22-A115)	
IC Latch-Up Test		Class I (per JESD78)	
RoHS Compliant		Yes	

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

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Поставка электронных компонентов

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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

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